









CEZ6R68AL

60V ▲ 7.8mΩ ▲ 41A ▲ Dual Si MOSFET

SILICON Si MOSFET ▲ SMD type Dual N-channel enhancement mode UL94V-0 rated flame retardant epoxy PPAK5x6 package ▲ MSL 3

Super high dense cell density for extremely low R_{DS(ON)} High power and current handling capability

MAXIMUM RATINGS

Parameter (T_c = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V _{DS}	60V
Gate-Source Voltage	V _{GS}	± 20V
Continuous Drain Current at R _{TH_JC}	I _D	41A
Continuous Drain Current at R _{TH_JA}	I _D	13A
Pulsed Drain Current at R _{TH_JC} Note 1	I _{DM}	164A
Pulsed Drain Current at R _{TH_JA} Note 1	I _{DM}	52A
Maximum Power Dissipation	P _D	31W
Single Pulsed Avalanche Energy Note 5	E _{AS}	60mJ
Single Pulsed Avalanche Current Note 5	I _{AS}	20A
Operating and Storage Temperature Range	T _J , T _{STG}	-55°C to +150°C

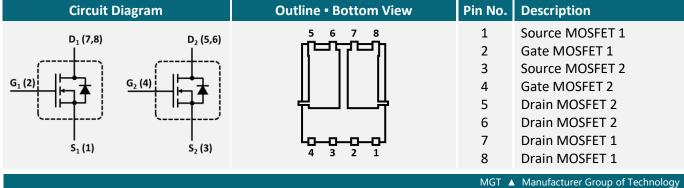
THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R _{TH_JC}	4°C/W
Thermal Resistance, Junction-to-Ambient Note 2	R _{TH JA}	40°C/W

APPLICATIONS

Audio	Battery Management	DC/DC	High Side	Low Side
Amplifier	Systems	Converter	Switches	Switches
((+4-			

PIN DESCRIPTION





ELECTRICAL CHARACTERISTICS ▲ T_C = 25°C, unless otherwise noted

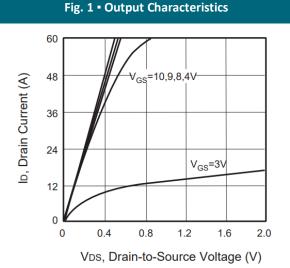
Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$, $I_D = 250\mu A$	BV_{DSS}	60			V
Zero Gate Voltage Drain Current	$V_{DS} = 60V$, $V_{GS} = 0V$	I _{DSS}			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 20V$, $V_{DS} = 0V$	I_{GSSF}			100	nA
Gate Body Leakage Current, Reverse	$V_{GS} = -20V, V_{DS} = 0V$	I_{GSSR}			-100	nA
On Characteristics Note 3						
Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_{D} = 250 \mu A$	$V_{GS(th)}$	1.2		2.5	V
Static Drain-Source On-Resistance	$V_{GS} = 10V$, $I_D = 4A$	R _{DS(ON)}		7.8	9.5	mΩ
Static Drain-Source On-Resistance	$V_{GS} = 4.5V$, $I_D = 3A$	R _{DS(ON)}		10	13	mΩ
Dynamic Characteristics Note 4						
Input Capacitance	$V_{DS} = 25V$, $V_{GS} = 0V$, $f = 1MHz$	C _{ISS}		865		pF
Output Capacitance	$V_{DS} = 25V$, $V_{GS} = 0V$, $f = 1MHz$	Coss		315		pF
Reverse Transfer Capacitance	$V_{DS} = 25V$, $V_{GS} = 0V$, $f = 1MHz$	C_{RSS}		5		pF
Switching Characteristics Note 4						
Turn-On Delay Time	V_{DD} = 30V, V_{GS} = 10V, I_D = 1A, $R_{G(ext)}$ = 6Ω	t _{D(ON)}		15		ns
Turn-On Rise Time	V_{DD} = 30V, V_{GS} = 10V, I_D = 1A, $R_{G(ext)}$ = 6Ω	t_{R}		4		ns
Turn-Off Delay Time	V_{DD} = 30V, V_{GS} = 10V, I_D = 1A, $R_{G(ext)}$ = 6Ω	t _{D(OFF)}		37		ns
Turn-Off Fall Time	V_{DD} = 30V, V_{GS} = 10V, I_D = 1A, $R_{G(ext)}$ = 6Ω	t _F		18		ns
Total Gate Charge	$V_{DS} = 48V$, $V_{GS} = 4.5V$, $I_{D} = 10A$	Q_{G}		8.3		nC
Gate Source Charge	$V_{DS} = 48V$, $V_{GS} = 4.5V$, $I_{D} = 10A$	Q_{GS}		2.3		nC
Gate Drain Charge	$V_{DS} = 48V$, $V_{GS} = 4.5V$, $I_{D} = 10A$	Q_{GD}		3.8		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode Forward Current Note 2		I _S			25	Α
Drain-Source Diode Forward Voltage Note 3	$V_{GS} = 0V$, $I_S = 14A$	V_{SD}			1.2	V

Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Surface Mounted on FR4 Board, t < 10 sec
- 3: Pulse Test: Pulse Width < 300μs, Duty Cycle < 2%.
- 4: Guaranteed by design, not subject to production testing.
- 5: L = 0.3mH, $I_{AS} = 20$ A, $V_{DD} = 24$ V, $R_G = 25$ Ω, Starting $T_J = 25$ °C



REFERENCE DATA A TYPICAL DEVICE PERFORMANCE



100 (V) 80 100 25°C 40 T_J=1<u>25°C</u> -55°C

Fig. 2 • Transfer Characteristics

Fig. 3 • Capacitance

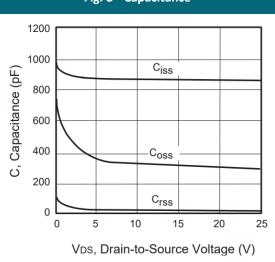


Fig. 4 • On-Resistance Variation with Temperature

Vgs, Gate-to-Source Voltage (V)

0

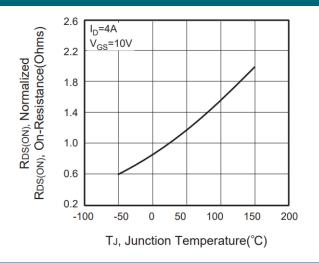


Fig. 5 • Gate Threshold Variation with Temperature

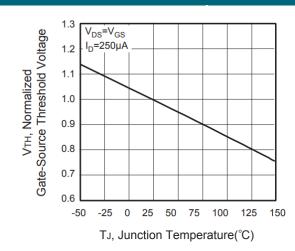
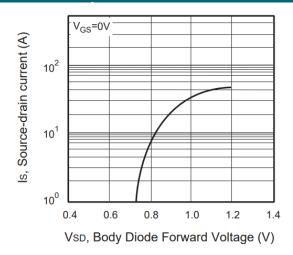


Fig. 6 • Body Diode Forward Voltage Variation with Source Current



MGT ▲ Manufacturer Group of Technology



REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

Fig. 7 • Gate Charge

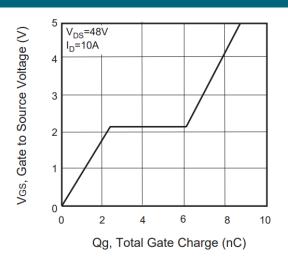


Fig. 8 • Maximum Safe Operating Area

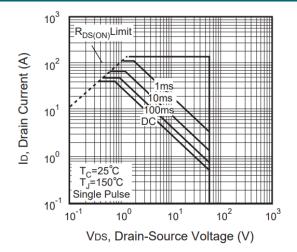
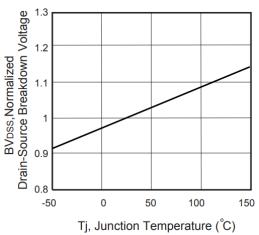


Fig. 9 • Breakdown Voltage Variation vs. Temperature





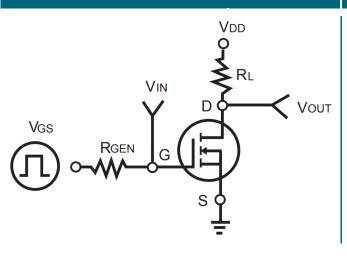
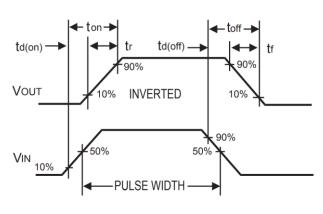


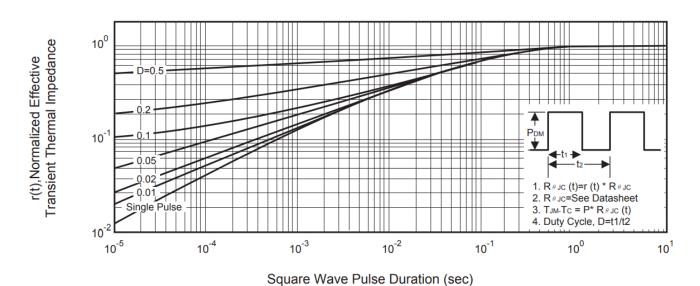
Fig. 11 • Switching Waveforms



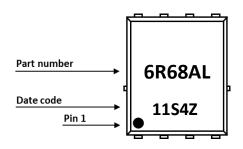


REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

Fig. 12 • Normalized Thermal Transient Impedance Curve

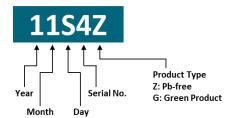


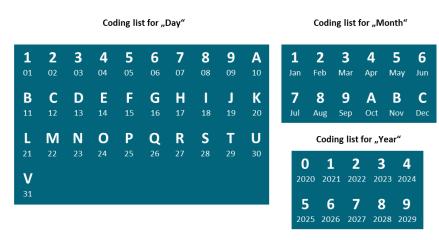
PART MARKING



DATE CODE

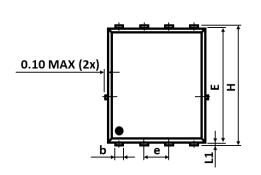
Example: 61S4Z

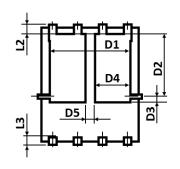


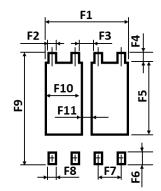


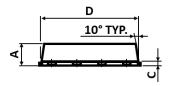


PACKAGE OUTLINE AND RECOMMENDED PAD LAYOUT









Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
Α	0.800	-	1.170
b	0.340	-	0.490
С	0.200	-	0.340
D	4.800	-	5.100
D1	3.800	-	4.200
D2	3.180	-	3.780
D3	0.150	-	0.360
D4	1.600	_	1.800

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	
D5	0.500	-	0.700	
Е	5.650	-	5.900	
e		1.270 TYP		
Н	5.900	-	6.150	
L1	0.050	-	0.250	
L2	0.380	-	0.620	
L3	0.380	-	0.750	

Sym	Millimeters (Min.)		
F1	-	4.500	-
F2	-	0.500	-
F3	-	0.770	-
F4	-	0.550	-
F5	-	3.650	-
F6	-	0.800	-

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F7	-	1.270	-
F8	-	0.500	-
F9	-	6.250	-
F10	-	1.950	-
F11	-	0.600	-

Notes: 1. The suggested land pattern dimensions have been provided for reference only.

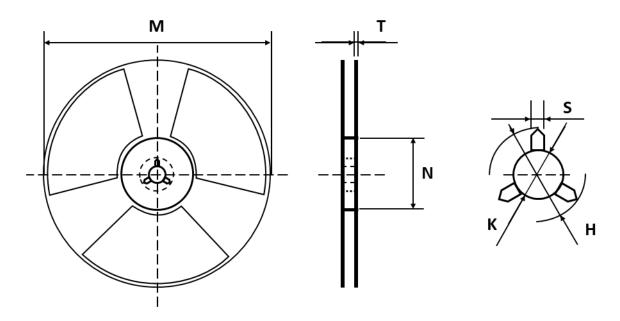
2. For further information, please reference document IPC-7351A.

ORDERING INFORMATION

Part Number	Package	Packing	Reel Qty.	Inner Box Qty.	Outer Box Qty.
CEZ6R68AL	PPAK 5x6	Reel	2,500pcs	5,000pcs	40,000pcs

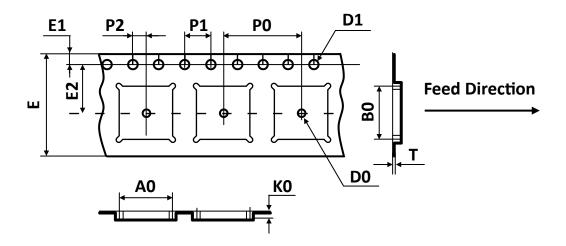


REEL DIMENSIONS ▲ All dimensions in mm



Tape Size	Reel Size	M	N	T	H	K	S
		Ø330.00	Ø100.00	2.10	22.00	13.00	2.00
12mm	Ø330	±2.00	±1.00	±0.20	±0.50	+0.50 -0.20	±0.50

TAPE DIMENSIONS ▲ All dimensions in mm

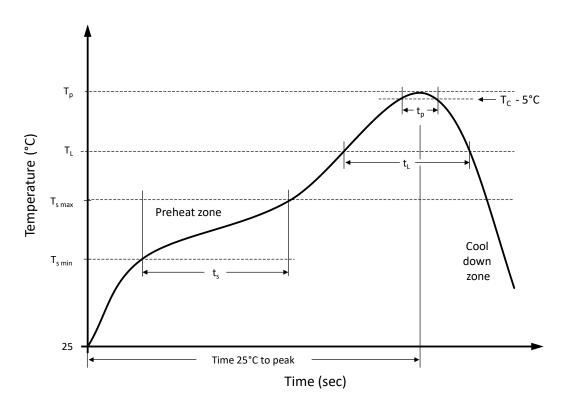


Package	Α0	В0	КО	D0	D1	Е	E1	E2	P0	P1	P2	T
	6.50	5.28	2.00	1.50	1.50	12.00	1.75	5.50	8.00	4.00	2.00	0.25
PPAK 5x6	±0.10	±0.10	±0.10	±0.25	±0.10	+0.30	±0.10	±0.05	±0.10	±0.10	±0.05	±0.02

Note: All dimensions meet EIA-481-D requirements.



RECOMMENDED REFLOW SOLDERING PROFILE



Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	150 °C
Preheat temperature max.	T _{s max}	150 °C	200 °C
Preheat time t _s from T _{s min} to T _{s max}	ts	120 seconds	120 seconds
Ramp-up rate (T₁ to Tp)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	T_L	183 °C	217 °C
Time t _L maintained above T _L	t _L	150 seconds max.	150 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t _p	20 seconds max.	30 seconds max.
Ramp-down rate (T _L to T _p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



REVISION TABLE

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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It is subject to the user's duty of care to design and validate his products in such a way that appropriate measures are taken, such as protective circuits or redundant systems to ensure the safety standards required in the application.

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